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# **Panasonic**

### BAV99

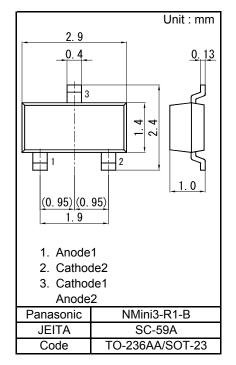
Silicon epitaxial planar type

For high speed switching circuits Panasonic parts No. DA3Y101F

#### ■ Features

- Small reverse current IR
- · Short reverse recovery time trr
- Halogen-free / RoHS compliant (EU RoHS / UL-94 V-0 / MSL:Level 1 compliant)
- Marking Symbol: A7
- Basic Part Number : Dual DA2J101 (Series)
- Packaging

Embossed type (Thermo-compression sealing): 3 000 pcs / reel (standard)



■ Absolute Maximum Ratings Ta = 25 °C

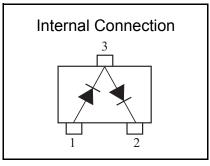
Parameter		Symbol	Rating	Unit	
Reverse voltage		VR	80	V	
Maximum peak reverse voltage	VRM	80	V		
Forward current	Single	IF	200	mA	
	Series	IF	100	mA	
Non-repetitive peak	Single	IFSM	500	mA	
forward surge current *1	Series	II SIVI	325	mA	
Junction temperature		Tj	150	°C	
Operating ambient temperature		Topr	-40 to +85	°C	
Storage temperature		Tstg	-55 to +150	°C	

Note) \*1 t = 1 s

Established: 2013-07-16

Revised

: ####-##-##



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Switching Diode

BAV99

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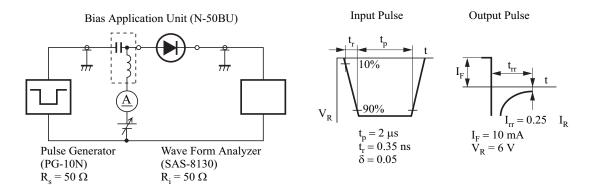
#### ■ Electrical Characteristics Ta = 25 °C ± 3 °C

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	VF	IF = 150 mA			1.25	V
Reverse voltage	VR	IR = 100 μA	80			V
Reverse current	IR	VR = 80 V			100	nA
Terminal capacitance	Ct	VR = 0 V, f = 1 MHz			1.2	pF
Reverse recovery time *1	trr	IF = 10 mA, VR = 6 V			3	ns
	ui	Irr = $0.25 \times IR$				

- Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 Measuring methods for Diodes.
  - 2. Absolute frequency of input and output is 100 MHz.
  - 3. \*1 trr test circuit

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Revised

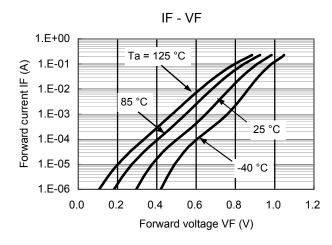


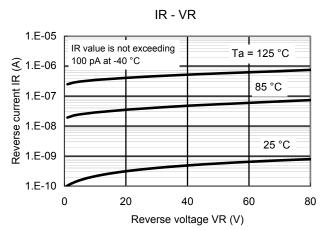
Switching Diode

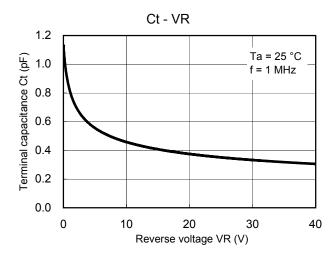
BAV99

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### Technical Data (reference)







Established : 2013-07-16 Revised : ###-##-##

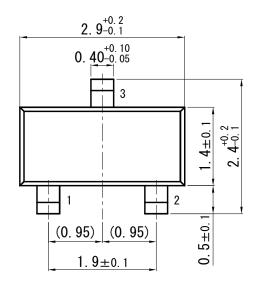
Switching Diode

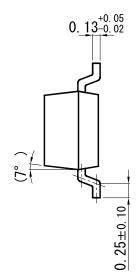
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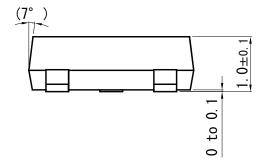
## NMini3-R1-B

**Panasonic** 

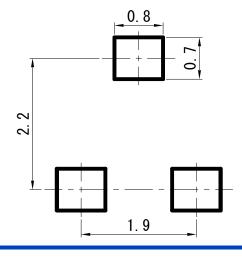
Unit: mm







### ■ Land Pattern (Reference) (Unit: mm)



Established : 2013-07-16 Revised : ###-##-##

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